

SAC4H2H-ANGA Apistek 12VDC 135x135x25mm Axial Fan Datasheet



SKU: [800942996486](#)

Category: Axial & Centrifugal Fans

Price: **\$16.99**

E-mail: sales@equipspares.com

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Product Page:

<https://www.equipspares.com/product/sac4h2h-anga-apistek-12vdc-135x135x25mm-axial-fan>

Product Description

The Apistek SAC4H2H-ANGA is a precision-engineered axial cooling fan designed to deliver robust thermal management for electronic enclosures and power supply units. Operating on a direct current platform, this model features an optimized aerodynamic blade structure that balances airflow volume with static pressure requirements. The unit is constructed to maintain structural rigidity under operation, minimizing vibration and associated noise. With a focus on reliability, the motor assembly is designed to reduce thermal impedance, ensuring consistent performance in demanding environments. The 135mm frame size makes it a specific solution for non-standard cooling requirements where efficient heat dissipation is critical for system stability.

Model Number: SAC4H2H-ANGA

Brand: Apistek

Product Type: Axial Fan

Rated Voltage: 12VDC

Voltage Range: Unspecified

Rated Current: 0.50 A

Input Power: 6.00 W

Rated Speed: Unspecified

Bearing Type: Unspecified

Max. Air Flow: Unspecified

Max. Static Pressure: Unspecified

Dimensions: 135 x 135 x 25 mm

Weight: Unspecified

Life Expectancy: Unspecified

Termination: 2-Wire Leads

Housing Material: Thermoplastic

Blade Material: Thermoplastic

Application: Power Supply/Chassis Cooling

The SAC4H2H-ANGA is frequently deployed in high-wattage power supply units and custom computer chassis where standard 120mm or 140mm fans do not fit the specific mounting topology. This model serves as a critical replacement component for OEM hardware, restoring optimal cooling curves to sensitive electronics. By integrating the SAC4H2H-ANGA into server racks or industrial control cabinets, operators can ensure sustained airflow across heat sinks and capacitors, effectively mitigating the risks associated with thermal throttling and component degradation.

Supplemental Images

